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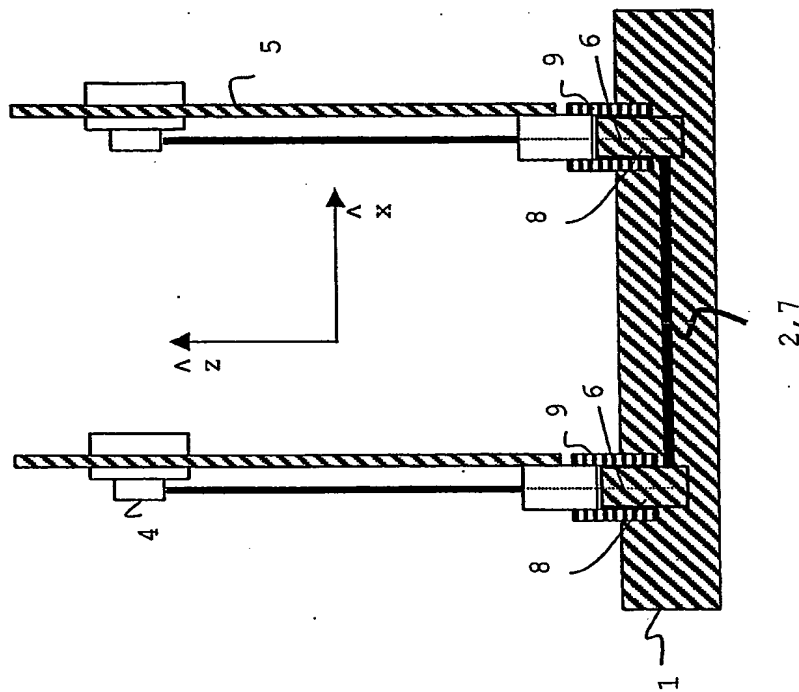


Fig. 1

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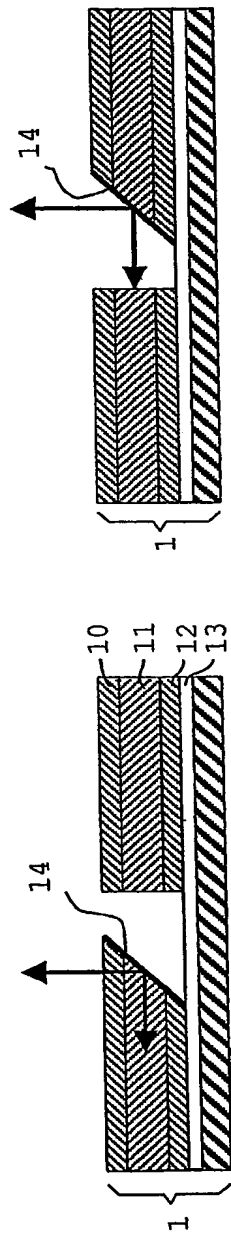


Fig. 2B

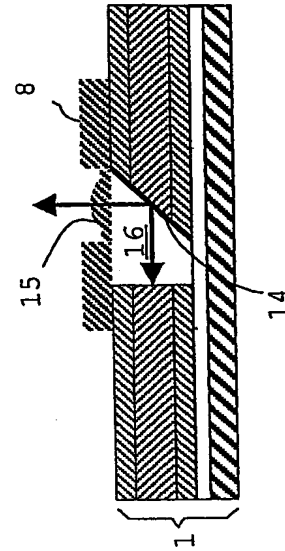


Fig. 2D

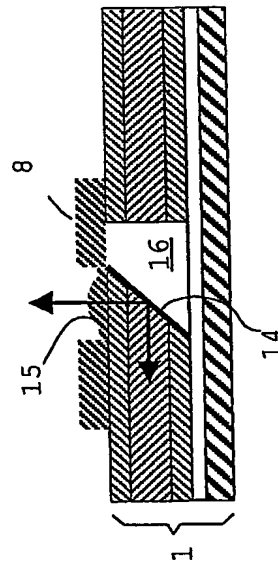
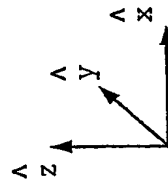


Fig. 2C

Fig. 2

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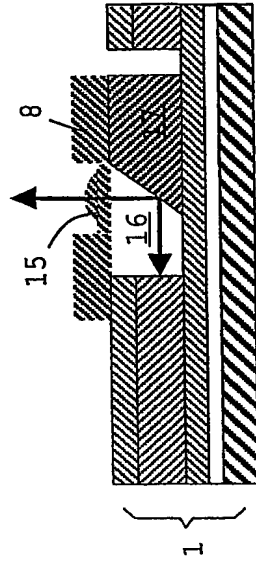


Fig. 2E

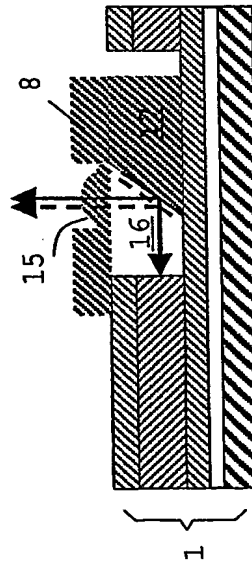


Fig. 2F

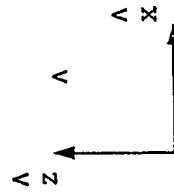


Fig. 2

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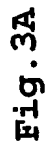


Fig. 3A

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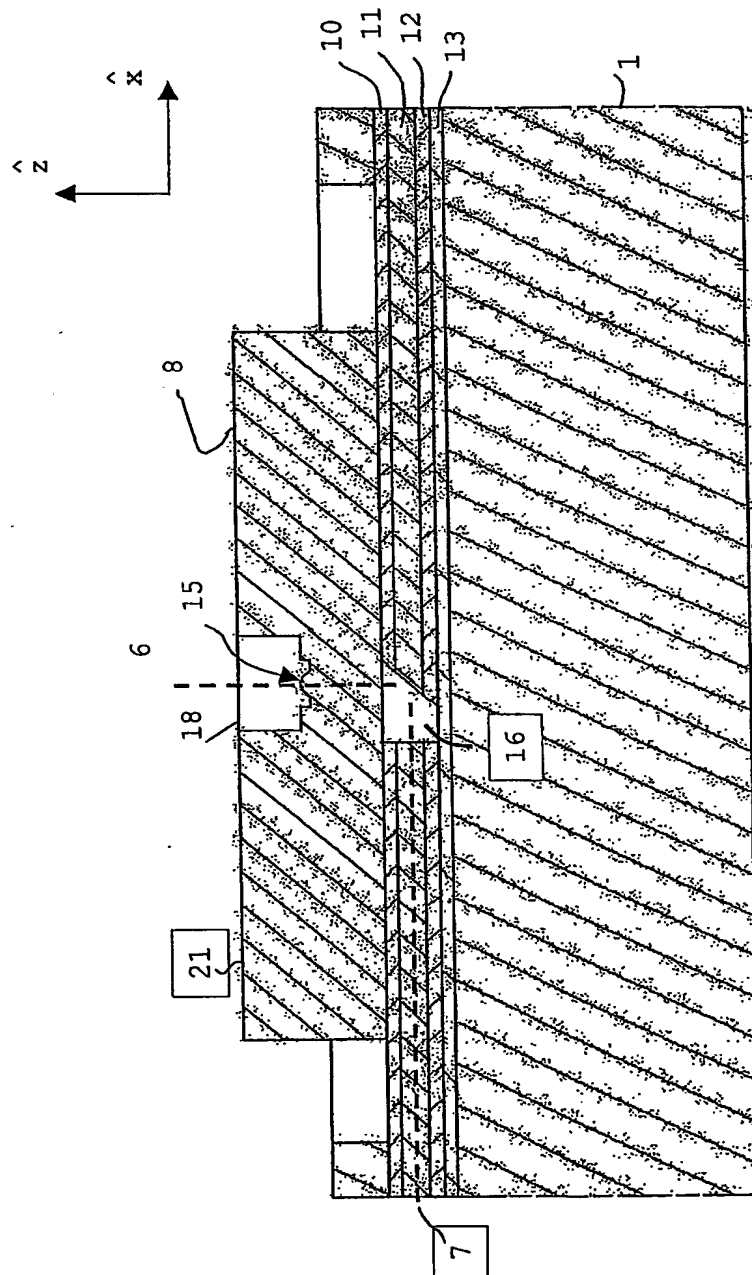


Fig. 3B

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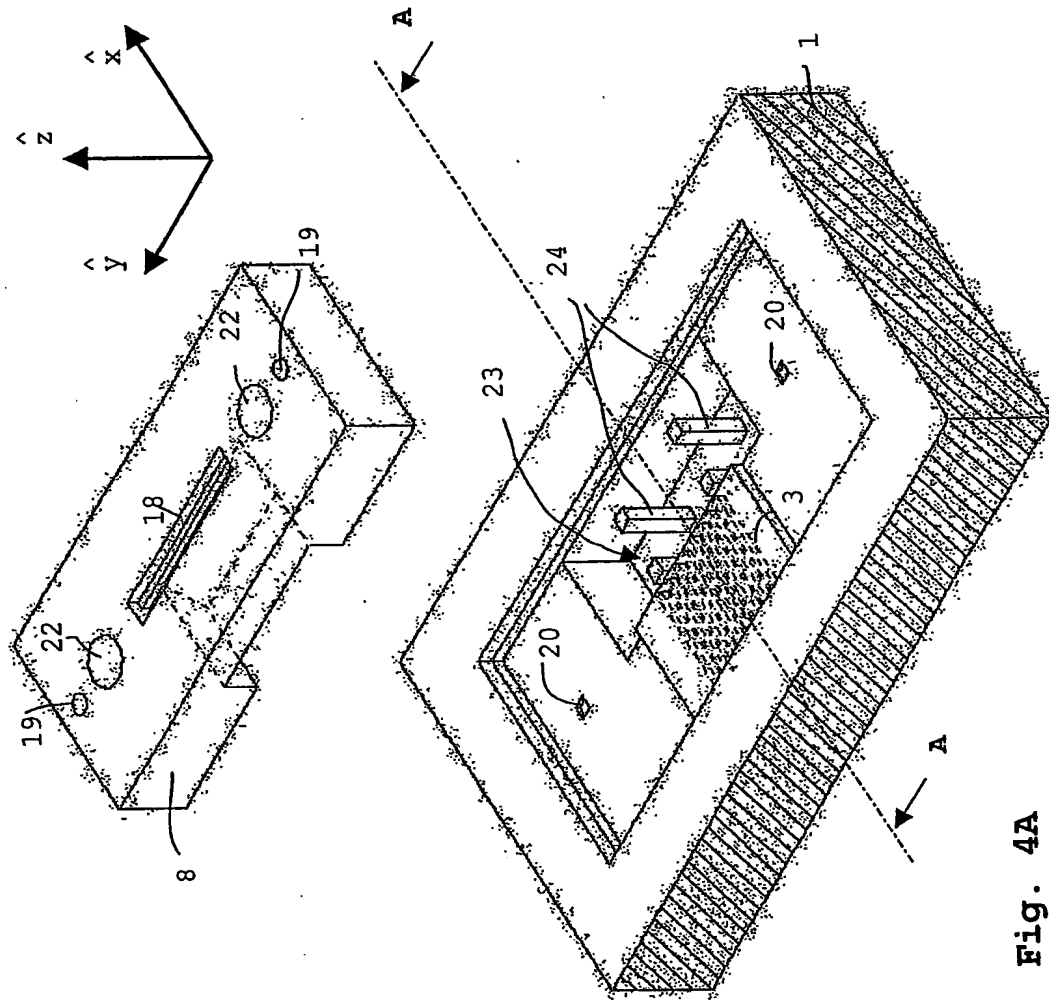


Fig. 4A

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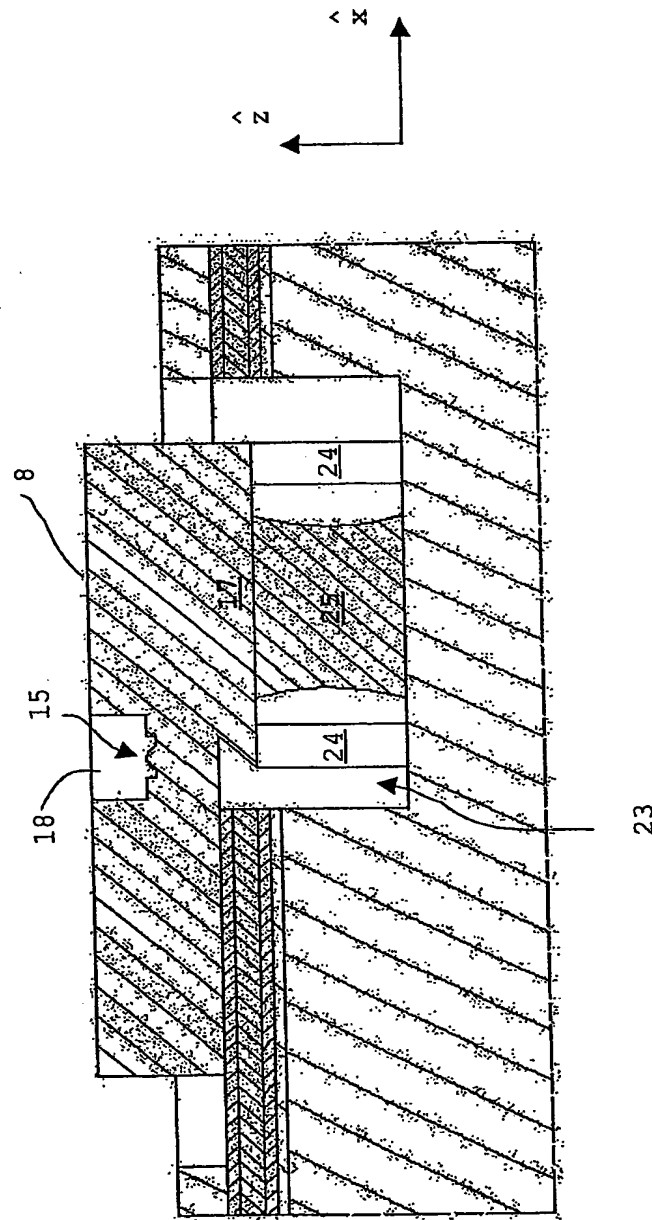


Fig. 4B

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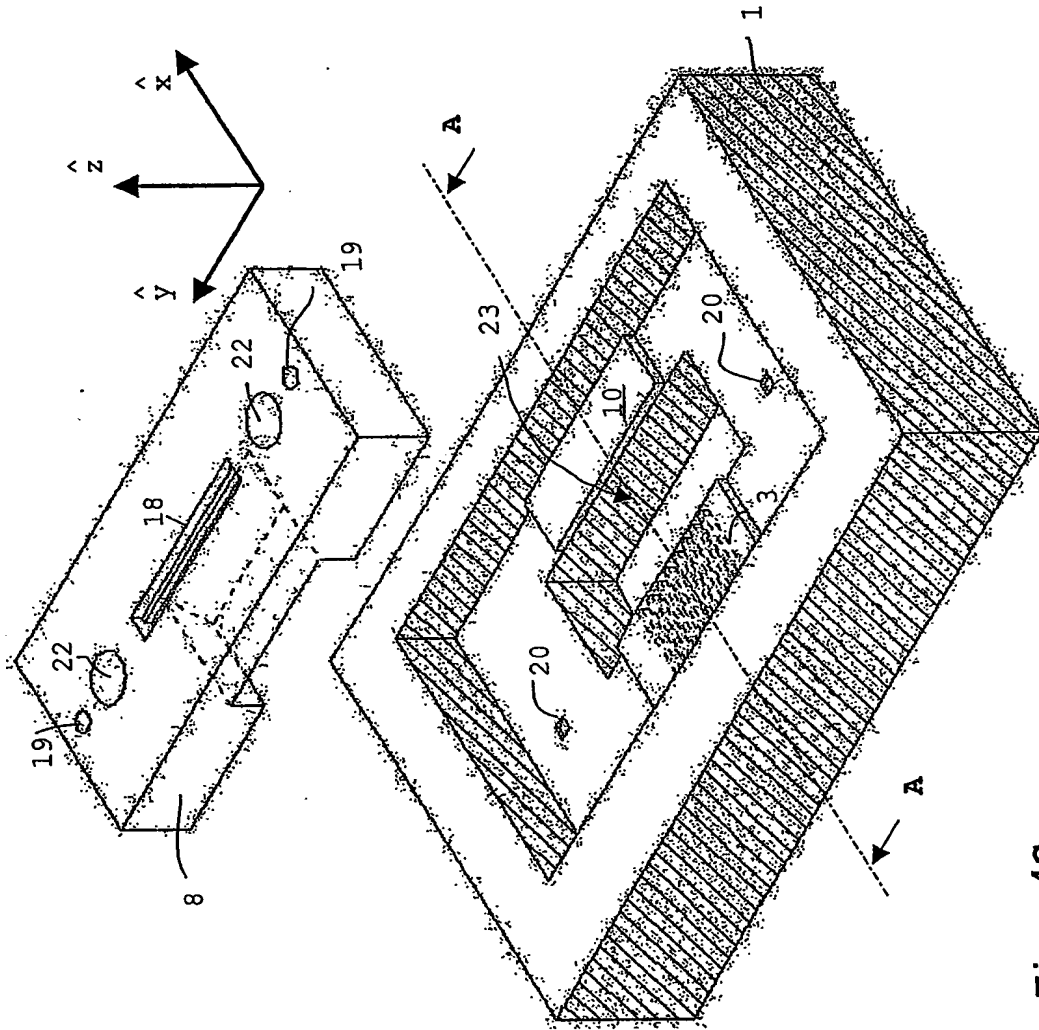


Fig. 4C

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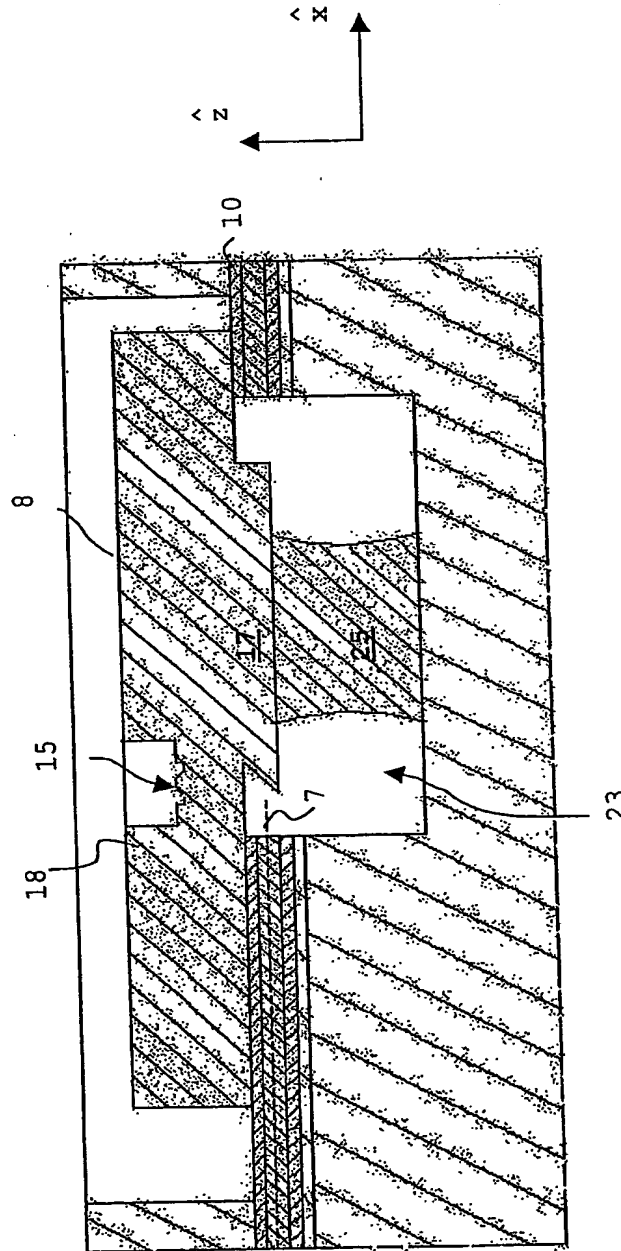
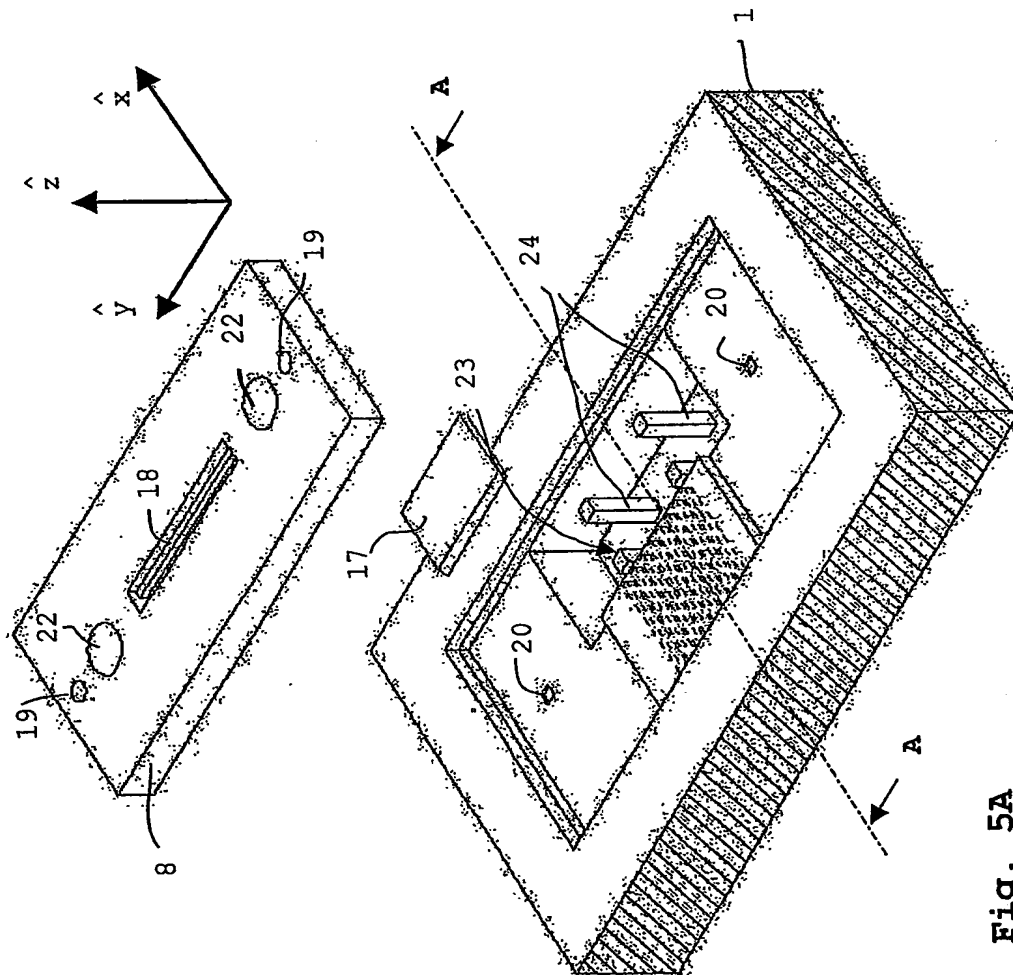
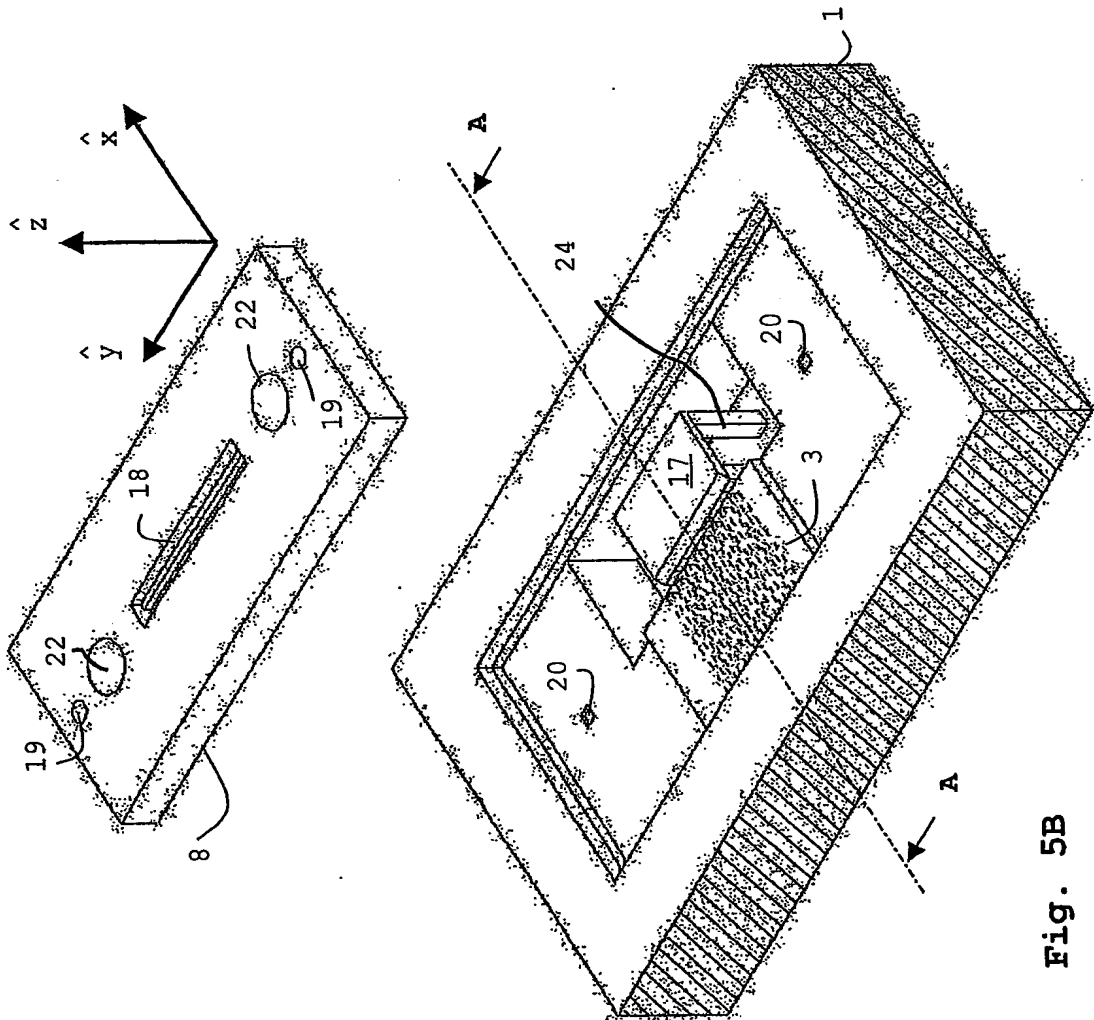


Fig. 4D

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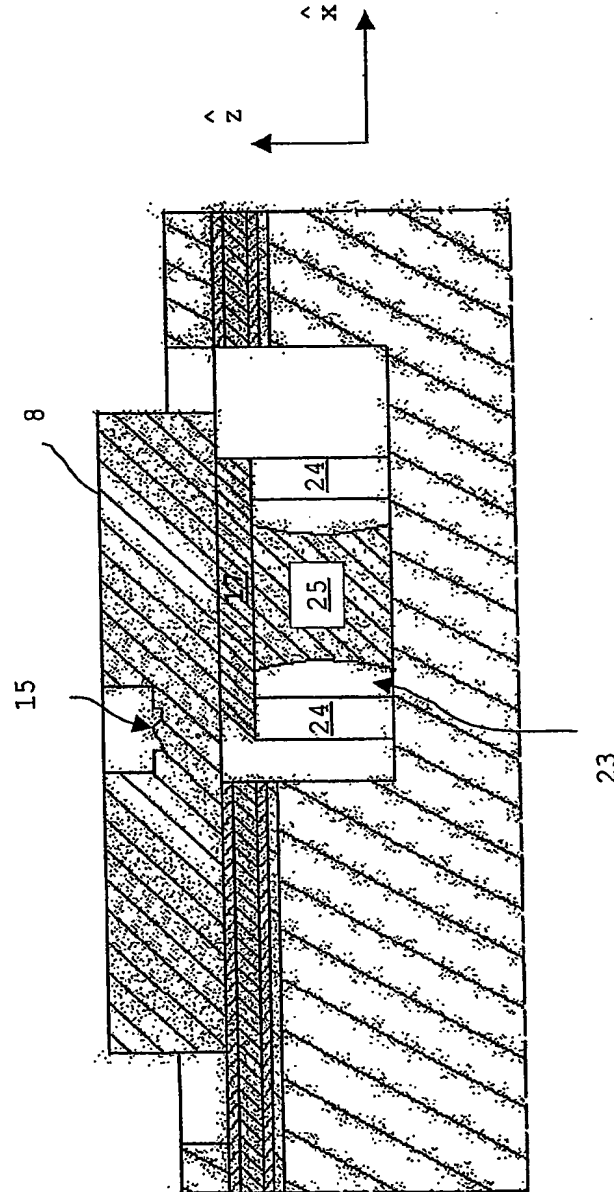


Fig. 5C

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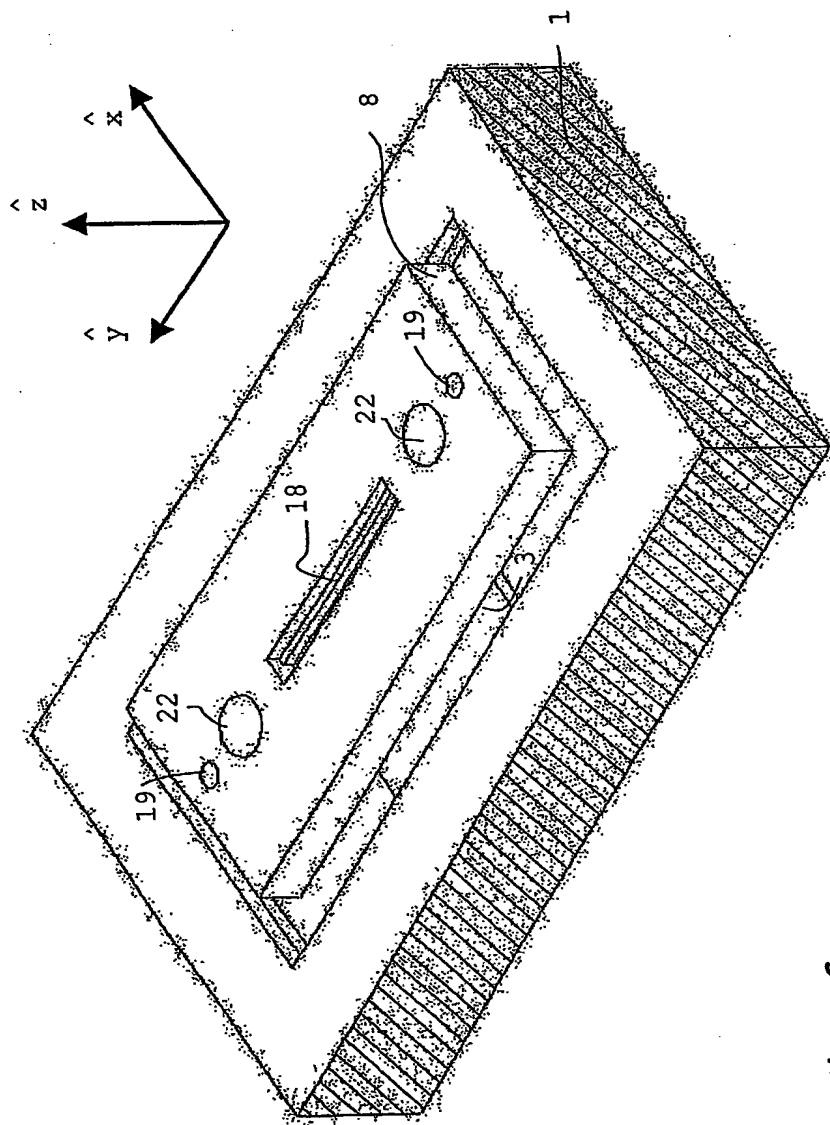


Fig. 6

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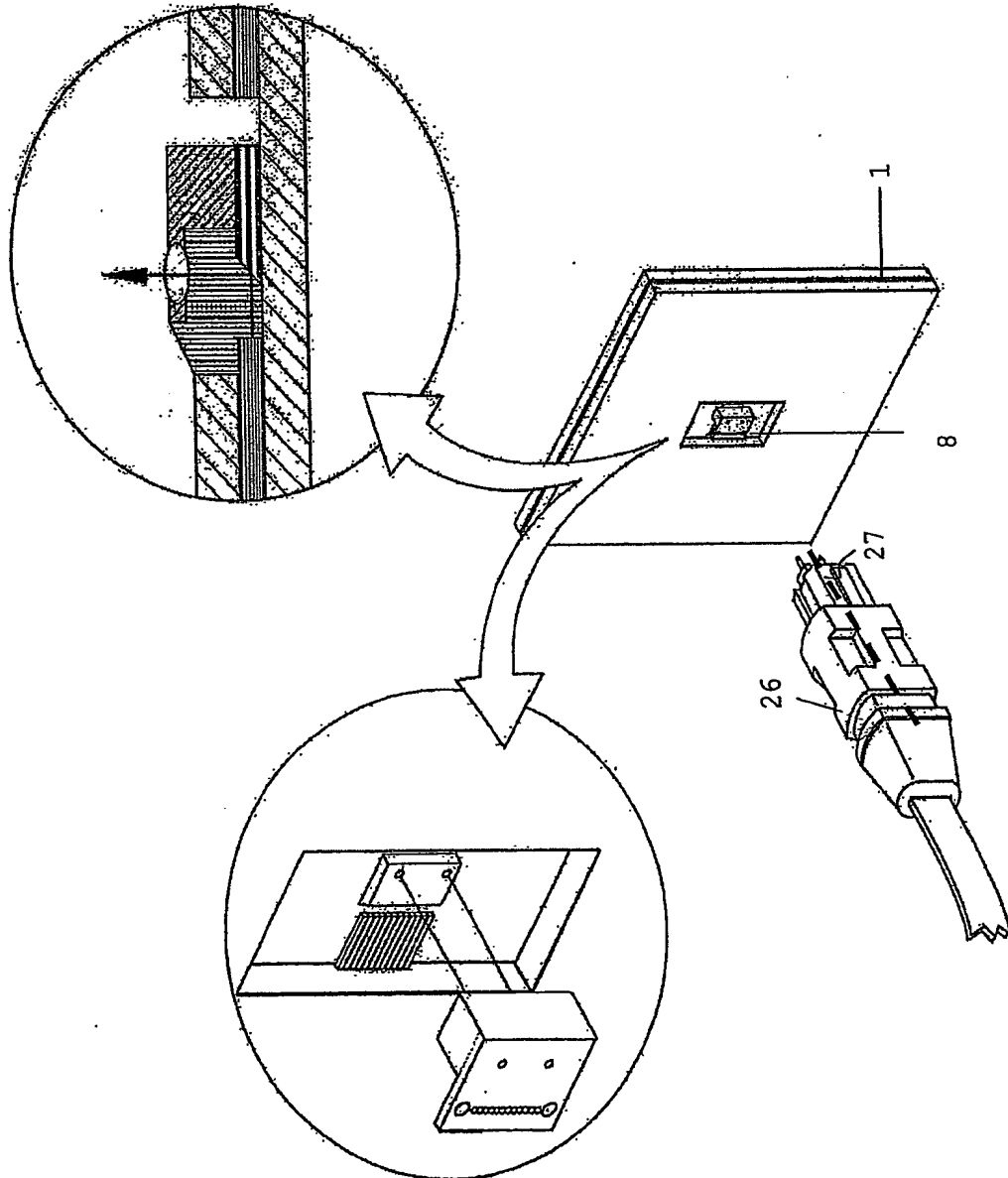


Fig. 7A

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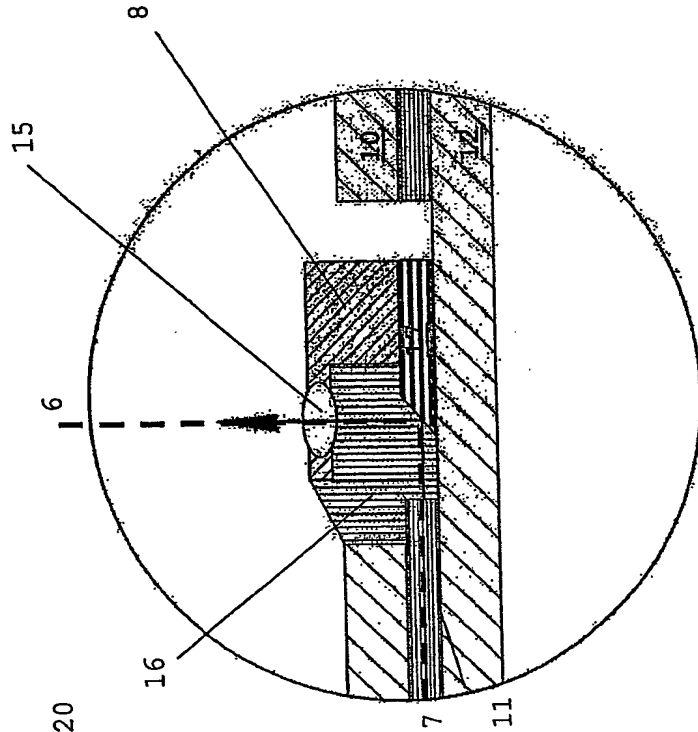


Fig. 7C

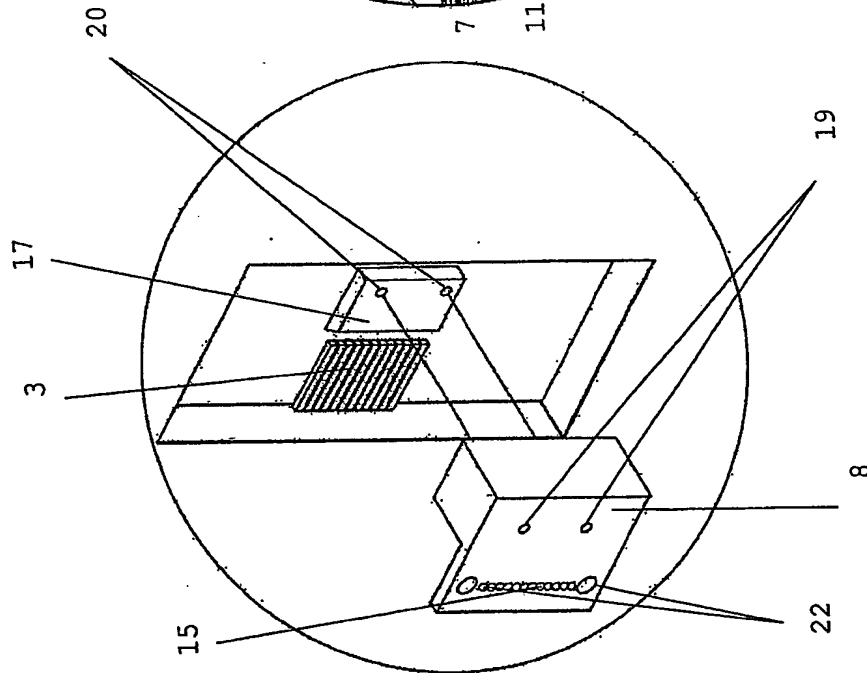


Fig. 7B

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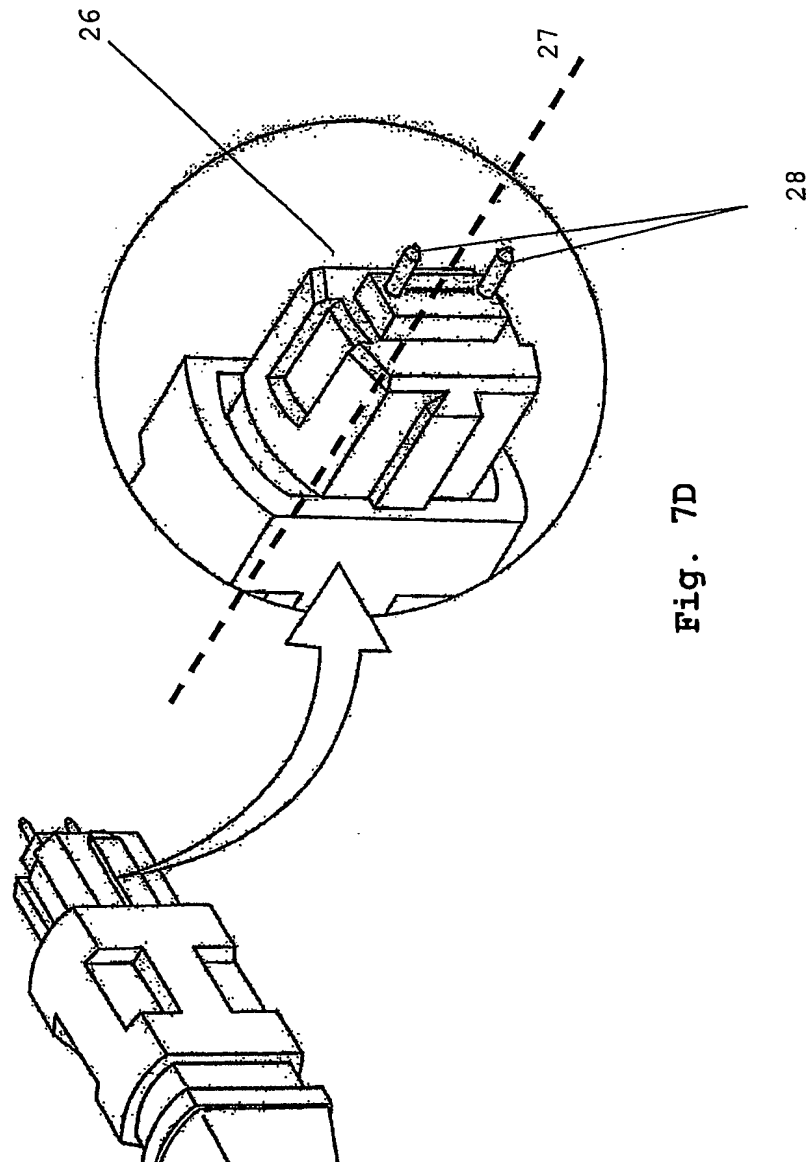


Fig. 7D

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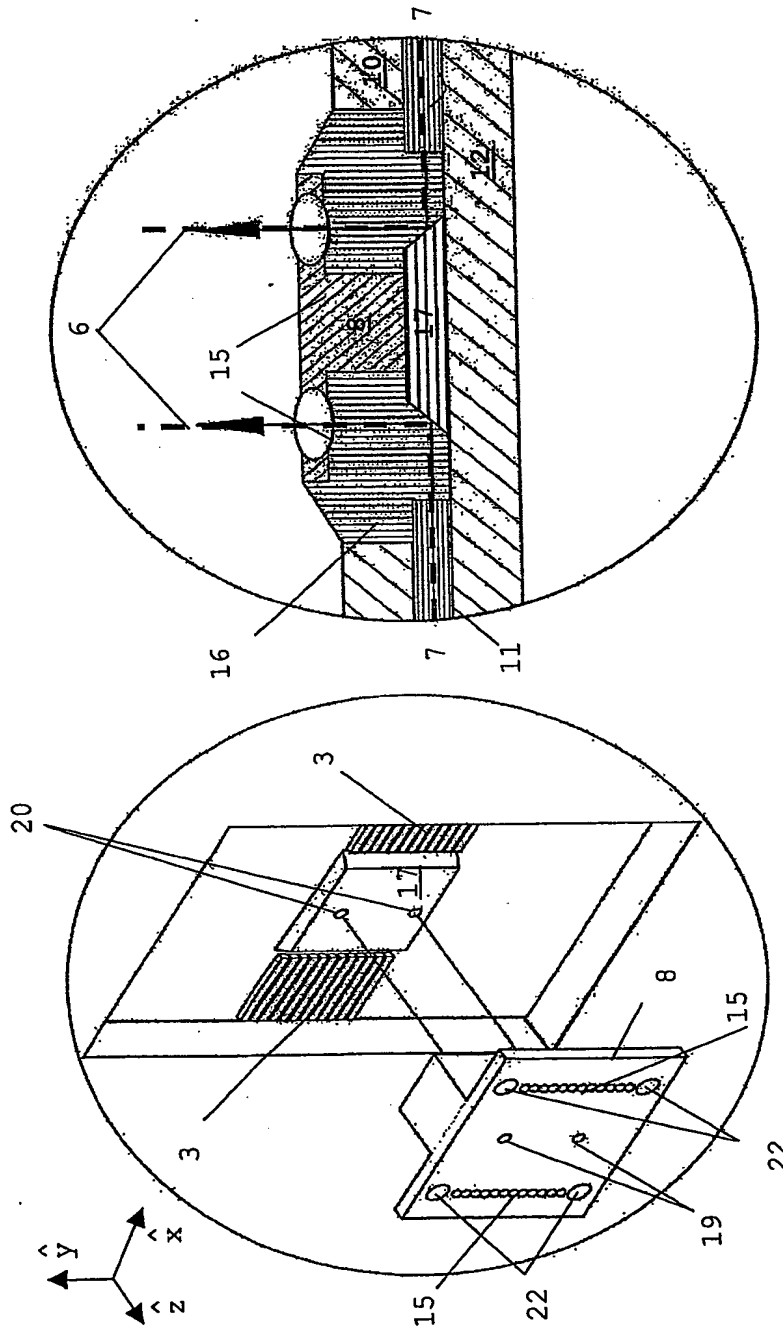


Fig. 7F

Fig. 7E

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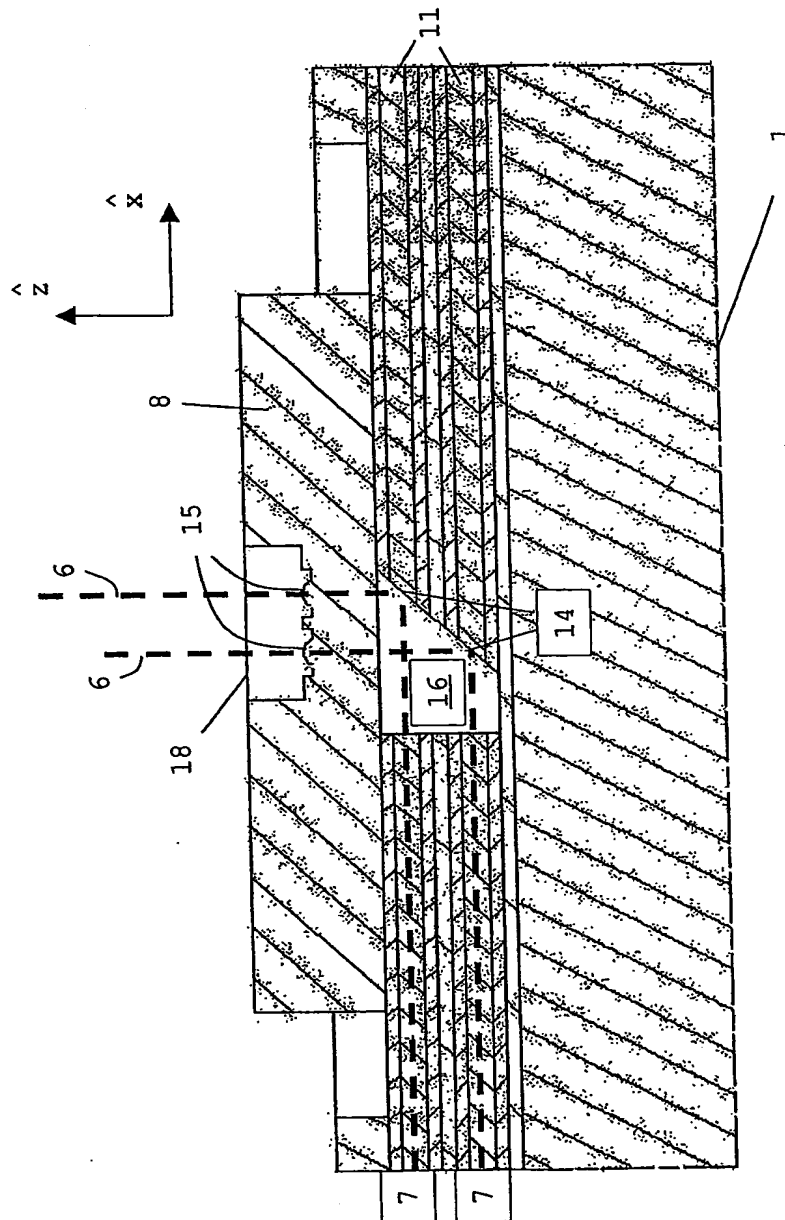


Fig. 8A

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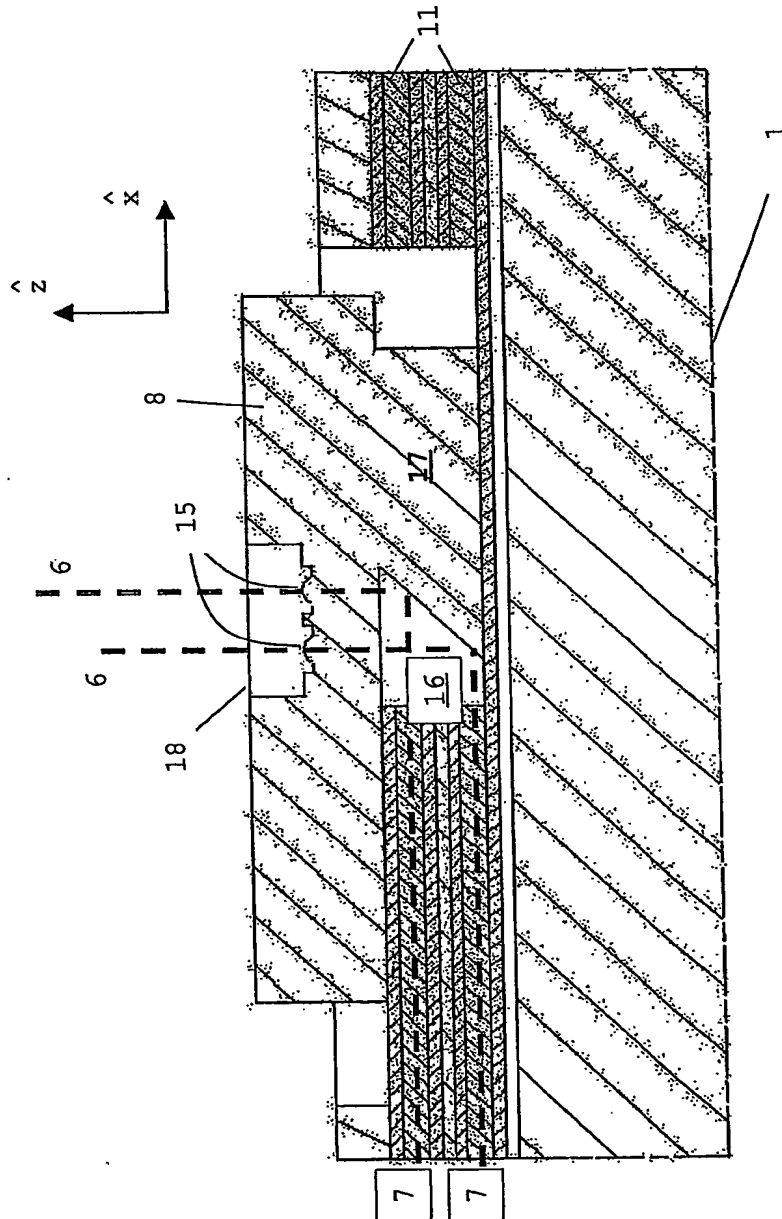


Fig. 8B

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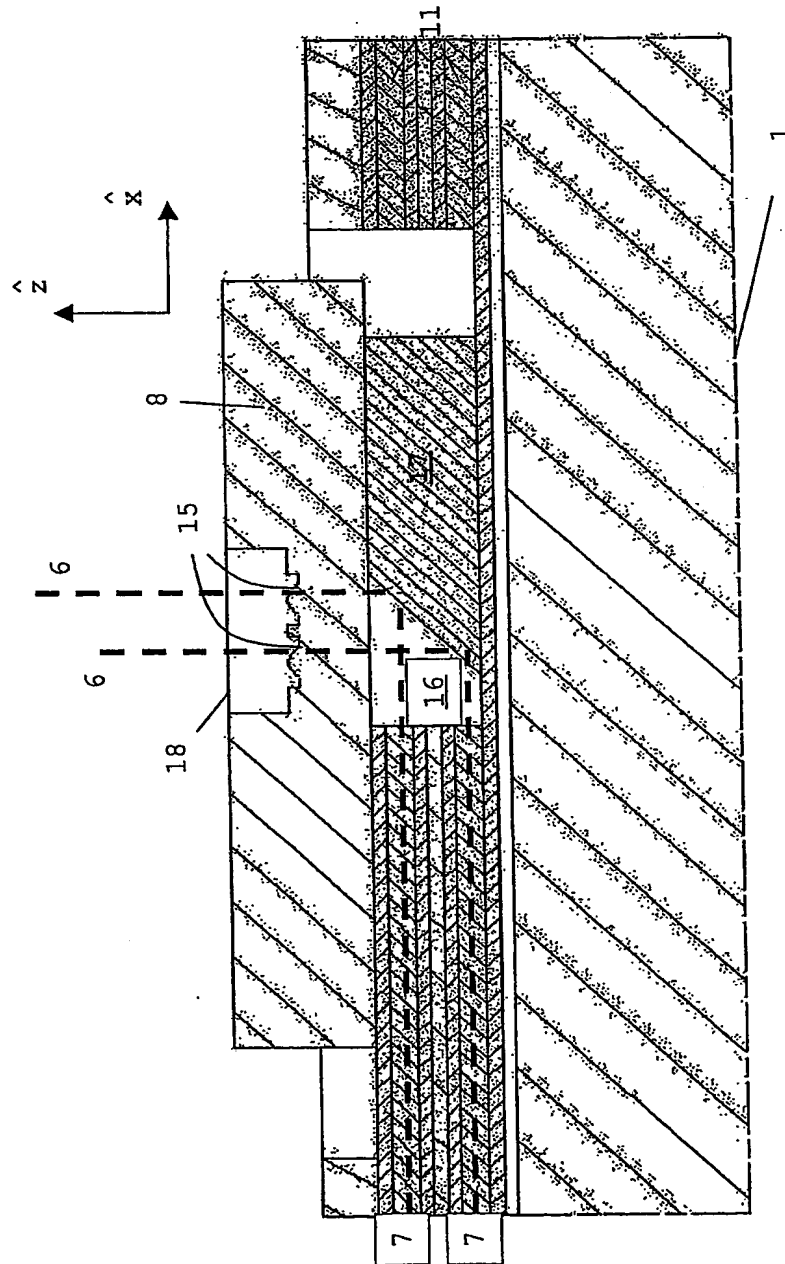


Fig. 8C

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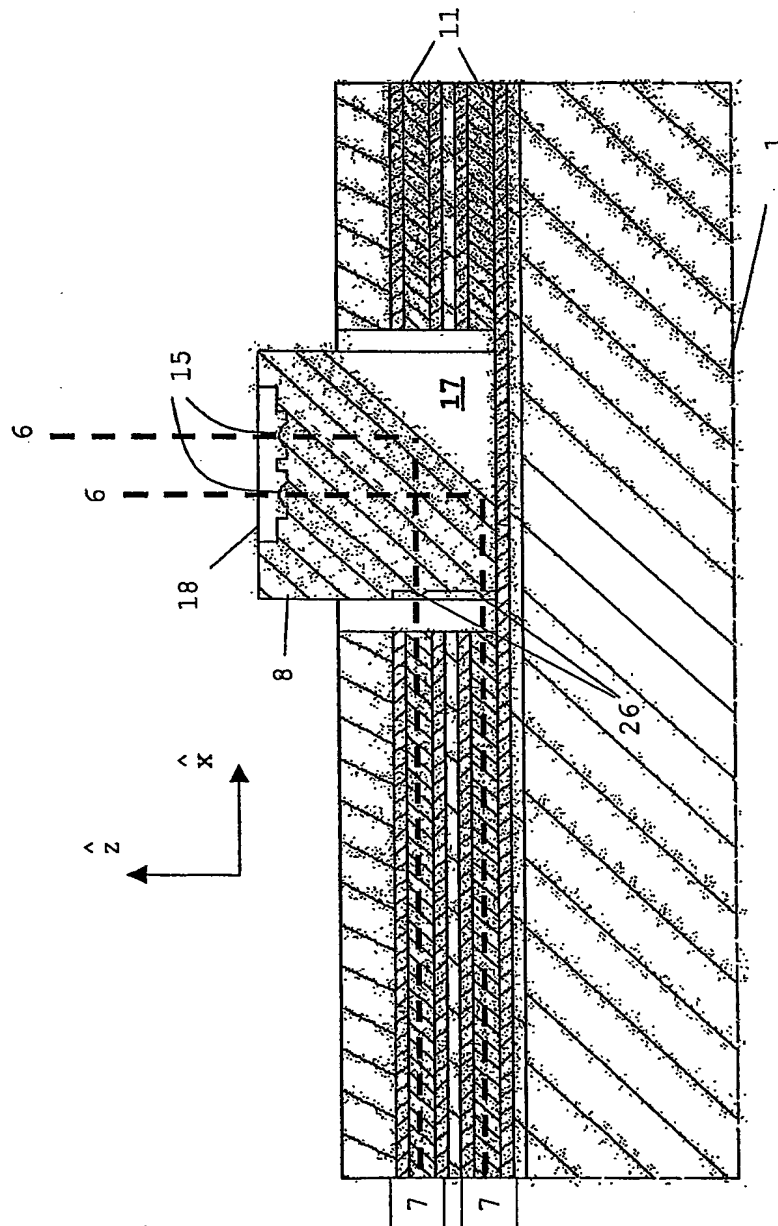


Fig. 8D